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Technical Information

ModSTACK™ HD

6MS30017E43W34404

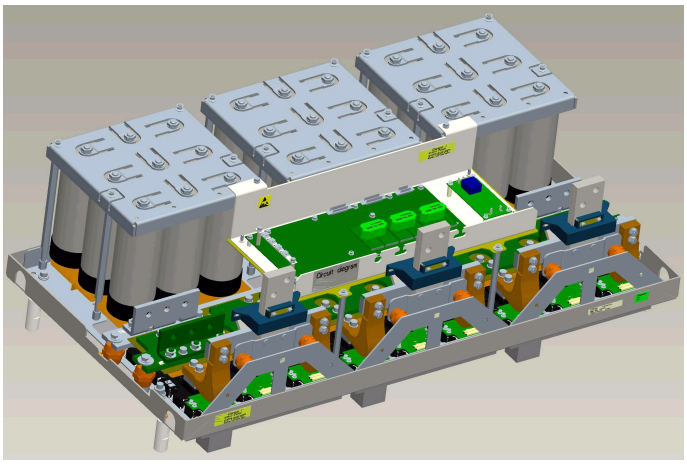
Preliminary data

General information

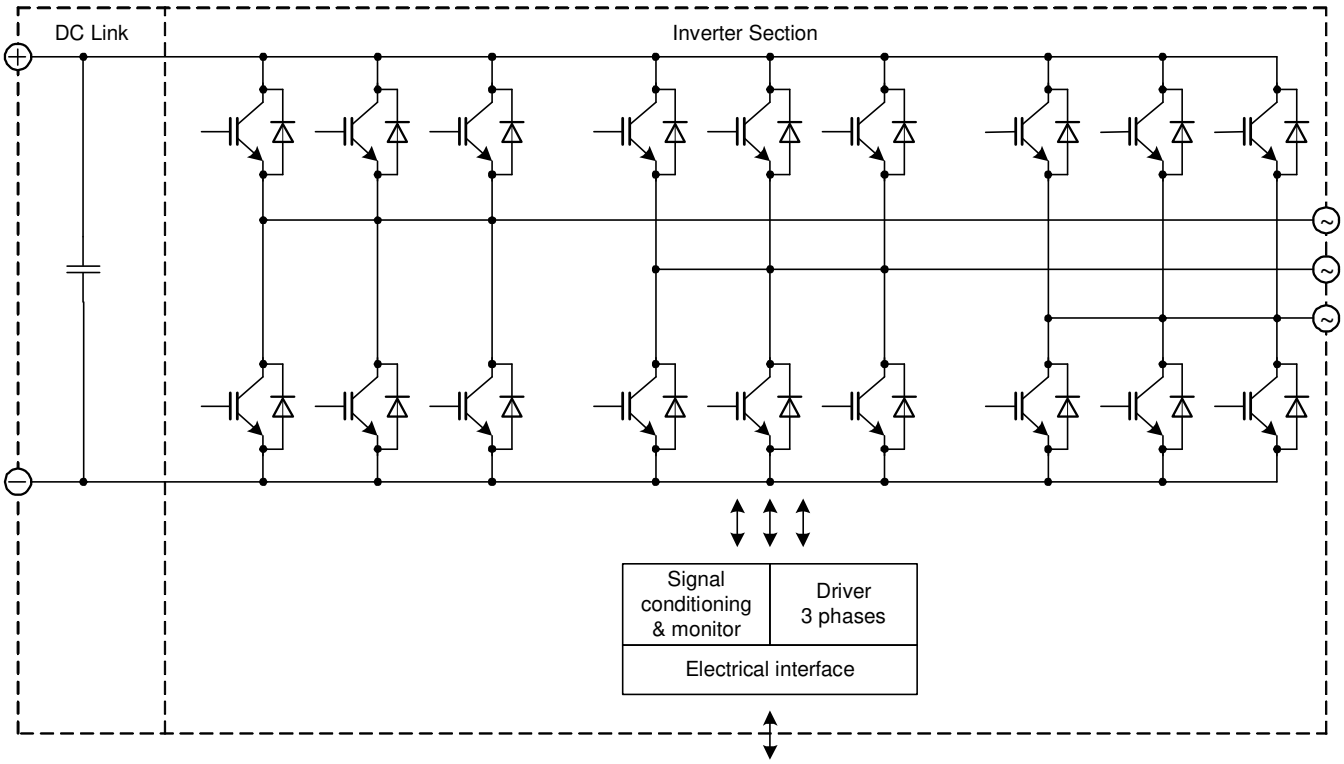
IGBT STACK for typical voltages of up to 690 V_{RMS}
Rated output current 2050 A_{RMS}

· High Power Converter
· Wind power
· Motor Drives

· PrimePACK™3 module and NTC
· Extended Operation Temperature
· Low V_{cesat}



Topology	B6I
Application	Inverter
Load type	Resistive, inductive
Semiconductor (Inverter Section)	9x FF1000R17IE4
DC Link	9.5 mF
Heatsink	Water cooled
Implemented sensors	Current, voltage, temperature
Driver signals IGBT	Electrical
Sales - name	6MS30017E43W34404
SP - No.	SP000793442



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Absolute maximum rated values

Collector-emitter voltage	IGBT; T_{vj} = 25°C	V_{CES}	1700	V
Repetitive peak reverse voltage	Diode; T_{vj} = 25°C	V_{RRM}	1700	V
DC link voltage		V_{DC}	1250	V
Insulation management	according to installation height of 2000 m	V_{line}	690	V_{RMS}
Insulation test voltage	according to EN 50178, f = 50 Hz, t = 1 s	V_{ISOL}	2.5	kV_{RMS}
Repetitive peak collector current inverter section (IGBT)	t_p = 1 ms	I_{CRM2}	4280	A
Repetitive peak forward current inverter section (Diode)	t_p = 1 ms	I_{FRM2}	4280	A
I^2t-value inverter section (Diode)	V_R = 0 V, t_p = 10 ms, T_{vj} = 125 °C	I^2t	378	kA^2s
Continuous current inverter section		I_{AC2}	2250	A_{RMS}
Junction temperature	under switching conditions	T_{vjop}	150	°C
Switching frequency inverter section		f_{sw2}	3	kHz

Notes
Further maximum ratings are specified in the following dedicated sections

Characteristic values

DC Link

			min.	typ.	max.	
Rated voltage		V_{DC}		1100	1200	V
Over voltage shutdown	within 150 µs			1250		V
Capacitor	1 s, 27 p, rated tol. ±10 %	C_{DC}		9.5		mF
		type		Foil		
Maximum ripple current	per device, T_{amb} = 55 °C	I_{ripple}			60	A_{RMS}
Balance or discharge resistor	per DC link unit	R_b		15.7		kΩ

Inverter Section

			min.	typ.	max.	
Rated continuous current	V_{DC} = 1100 V, V_{AC} = 690 V_{RMS}, cos(φ) = 0.85, $f_{AC\ sine}$ = 50 Hz, f_{sw} = 3000 Hz, T_{inlet} = 40°C, $T_j \leq$ 150 °C	I_{AC}			2050	A_{RMS}
Continuous current at low frequency	V_{DC} = 1100 V, V_{AC} = 690 V_{RMS}, $f_{AC\ sine}$ = 0 Hz, f_{sw} = 3000 Hz, T_{inlet} = 40 °C, $T_j \leq$ 150 °C	$I_{AC\ low}$			970	A_{RMS}
Rated continuous current for 150% overload capability	$I_{AC\ 150\%}$ = 2060 A_{RMS}, $t_{on\ over}$ = 60 s, $T_j \leq$ 150 °C	$I_{AC\ over1}$			1370	A_{RMS}
Rated continuous current for 150% overload capability	$I_{AC\ 150\%}$ = 2220 A_{RMS}, $t_{on\ over}$ = 3 s, $T_j \leq$ 150 °C	$I_{AC\ over2}$			1480	A_{RMS}
Over current shutdown	within 15 µs	$I_{AC\ OC}$			4280	A_{peak}
Power losses	I_{AC} = 2050 A, V_{DC} = 1100 V, V_{AC} = 690 V_{RMS}, cos(φ) = 0.85, $f_{AC\ sine}$ = 50 Hz, f_{sw} = 3000 Hz, T_{inlet} = 40 °C, $T_j \leq$ 150 °C	P_{loss}		32300		W

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Controller interface

Driver and interface board	ref. to separate Application Note			DR110		
				min.	typ.	max.	
Auxiliary voltage		V_{aux}	18	24	30	V
Auxiliary power requirement	V_{aux} = 24 V	P_{aux}		40		W
Digital input level	resistor to GND 1.8 kΩ, capacitor to GND 4 nF, logic high = on, min. 15 mA	$V_{in\ low}$	0		4	V
		$V_{in\ high}$	11		15	V
Digital output level	open collector, logic low = no fault, max. 15 mA	$V_{out\ low}$	0		1.5	V
		$V_{out\ high}$		15		V
Analog current sensor output inverter section	load max 1 mA, @ 2050 A_{RMS}	$V_{IU\ ana2}$ $V_{IV\ ana2}$ $V_{IW\ ana2}$	4.7	4.8	4.9	V
Analog DC link voltage sensor output	load max 1 mA, @ 1100 V	$V_{DC\ ana}$	7.7	7.9	8.1	V
Analog temperature sensor output inverter section (NTC)	load max 1 mA, @T_{NTC} = 65 °C, corresponds to T_j = 150 °C at rated conditions	$V_{Theta\ NTC2}$		7.9		V
Analog temperature sensor output inverter section (Simulated)	load max 1 mA, @T_{NTC} = 65 °C, corresponds to T_j = 150 °C at rated conditions	$V_{Theta\ sim2}$		9.8		V
Over temperature shutdown inverter section		$V_{Error\ OT2}$		10		V

System data

				min.	typ.	max.	
EMC robustness	according to 61800-3 at named interfaces	power	V_{Burst}		2		kV
		control	V_{Burst}		1		kV
		aux (24V)	V_{surge}		1		kV
Storage temperature			T_{stor}	-40		80	°C
Operational ambient temperature	PCB, DC link capacitor, bus bar, excluding cooling medium		$T_{op\ amb}$	-25		55	°C
Cooling air velocity	PCB, DC link capacitor, bus bar, standard atmosphere		V_{air}	2			m/s
Humidity	no condensation		Rel. F	0		95	%
Vibration	according to IEC 60721					5	m/s²
Shock	according to IEC 60721					40	m/s²
Protection degree					IP00		
Pollution degree					2		
Dimensions	width x depth x height			1090	596	366	mm
Weight					162		kg

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Heatsink water cooled

			min.	typ.	max.	
Water flow	according to coolant specification from Infineon	$\Delta V/\Delta t$	45			dm³/min
Water pressure					8	bar
Water pressure drop	at 45 dm³/min water flow	Δp		200		mbar
Coolant inlet temperature		T_{inlet}	-40		55	°C
Thermal resistance heatsink to ambient	per switch	$R_{th,ha}$		0.03		K/W
Cooling channel material				Aluminium		

Notes
Composition of coolant: Water and 52 vol. % Antifrogen N

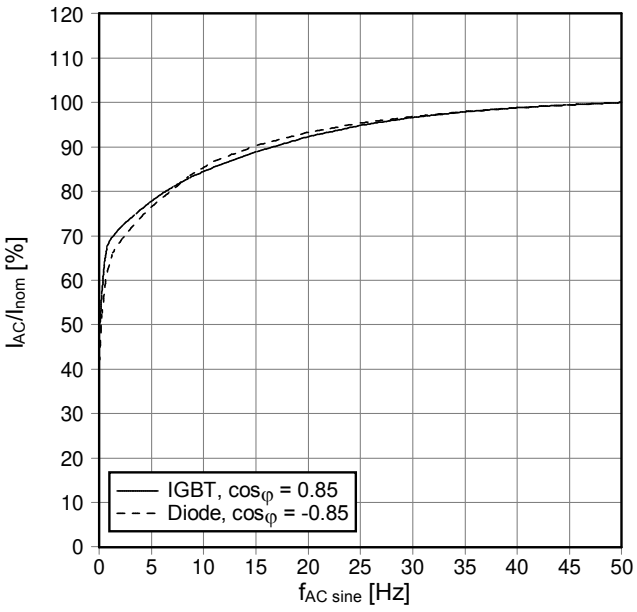
Overview of optional components

	Unit 1	Inverter Section	Unit 3
Parallel interface board			
Optical interface board			
Voltage sensor		×	
Current sensor		×	
Temperature sensor		×	
Temperature simulation		×	
DC link capacitors		×	
Collector-emitter Active Clamping		×	

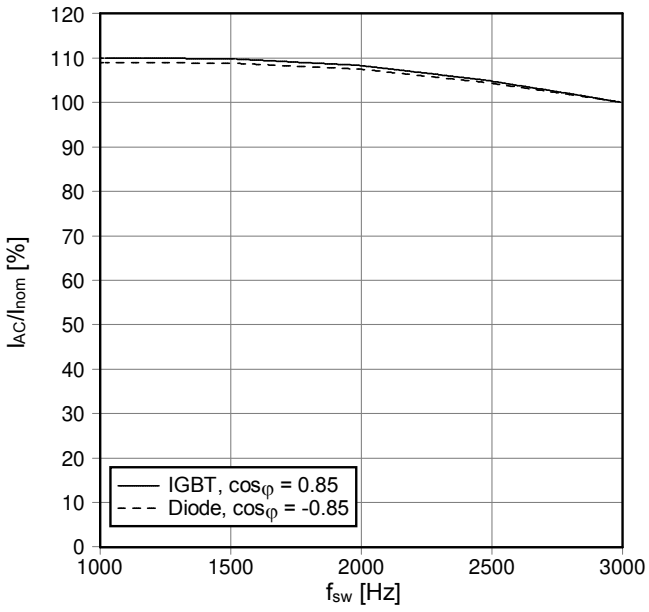
Notes
Setting of Active Clamping TVS-Diodes: V_Z = 1280 V

Preliminary data

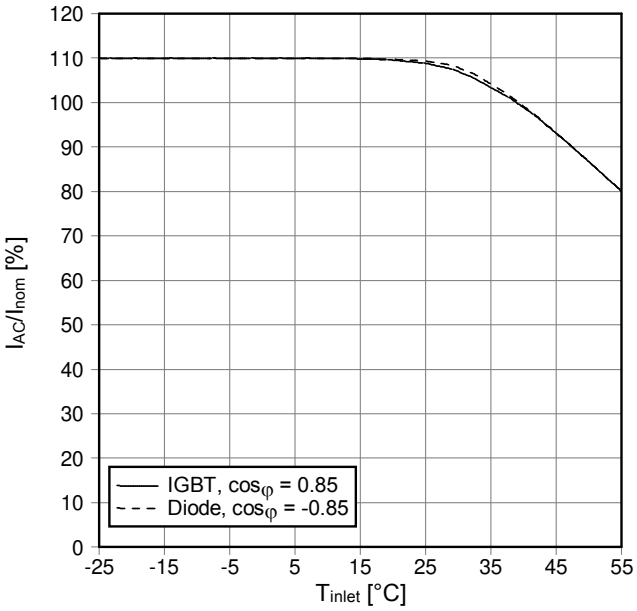
$f_{AC\ sine}$ - derating curve IGBT (motor), Diode (generator)
V_{DC} = 1100 V, V_{AC} = 690 V_{RMS}, f_{sw} = 3 kHz, $\cos\varphi$ = ±0.85,
T_{inlet} = 40 °C and nom. cooling conditions



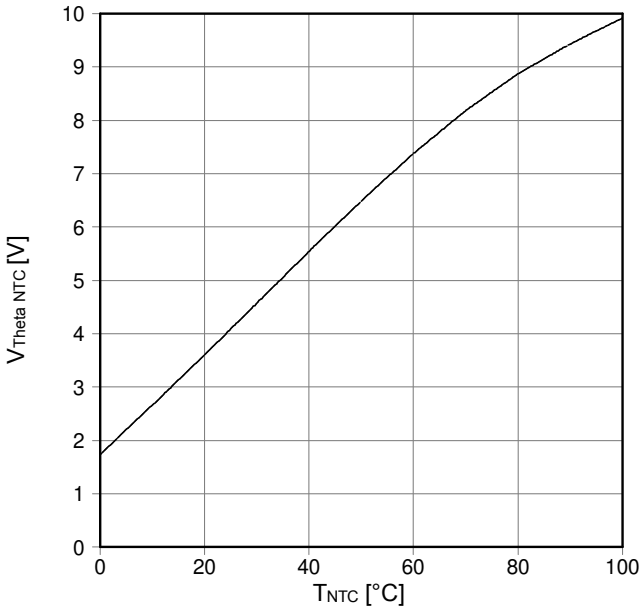
f_{sw} - derating curve IGBT (motor), Diode (generator)
V_{DC} = 1100 V, V_{AC} = 690 V_{RMS}, $f_{AC\ sine}$ = 50 Hz, $\cos\varphi$ = ±0.85,
T_{inlet} = 40 °C and nom. cooling conditions



T_{inlet} - derating curve IGBT (motor), Diode (generator)
V_{DC} = 1100 V, V_{AC} = 690 V_{RMS}, f_{sw} = 3 kHz, $f_{AC\ sine}$ = 50 Hz,
$\cos\varphi$ = ±0.85 and nom. cooling conditions



Analog temperature sensor output $V_{Theta\ NTC}$
Sensing NTC of IGBT module



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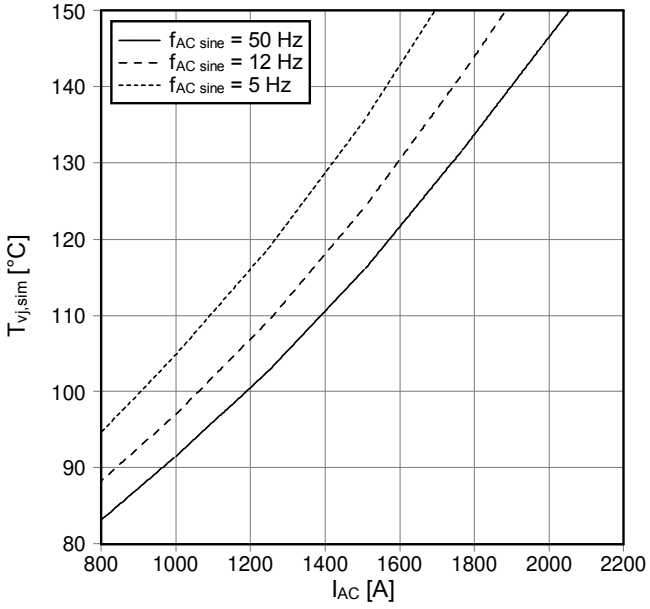
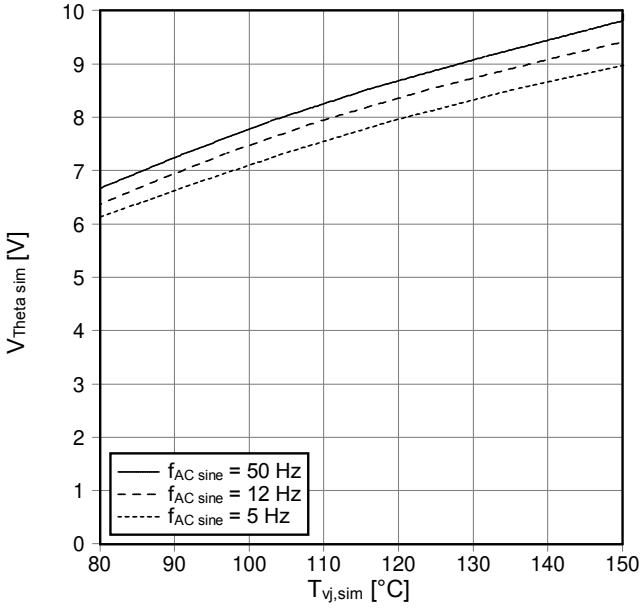
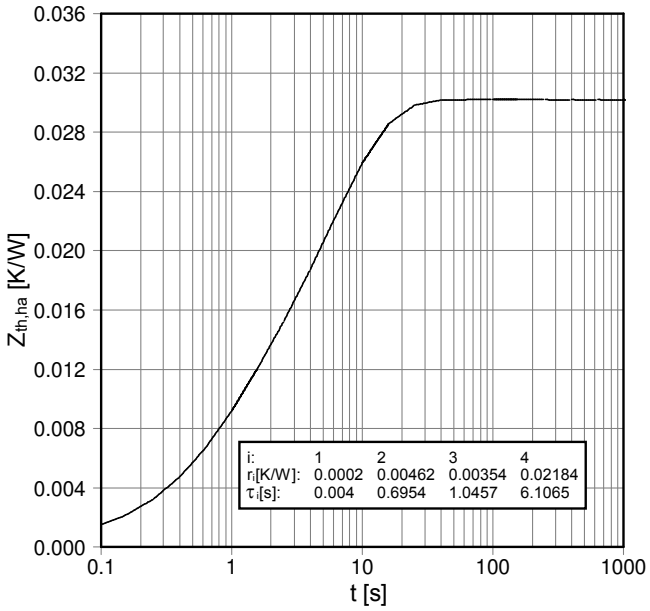
$T_{vj,sim}$ vs. I_{AC} - Simulated junction temperatur
V_{DC} = 1100 V, V_{AC} = 690 V_{RMS}, f_{sw} = 3 kHz,
T_{inlet} = 40 °C and nom. cooling conditions



Analog temperature sensor output $V_{Theta\ sim}$
V_{DC} = 1100 V, V_{AC} = 690 V_{RMS}, f_{sw} = 3 kHz,
nom. cooling conditions



$Z_{th,ha}$ - thermal impedance heatsink to ambient per switch
nom. cooling conditions



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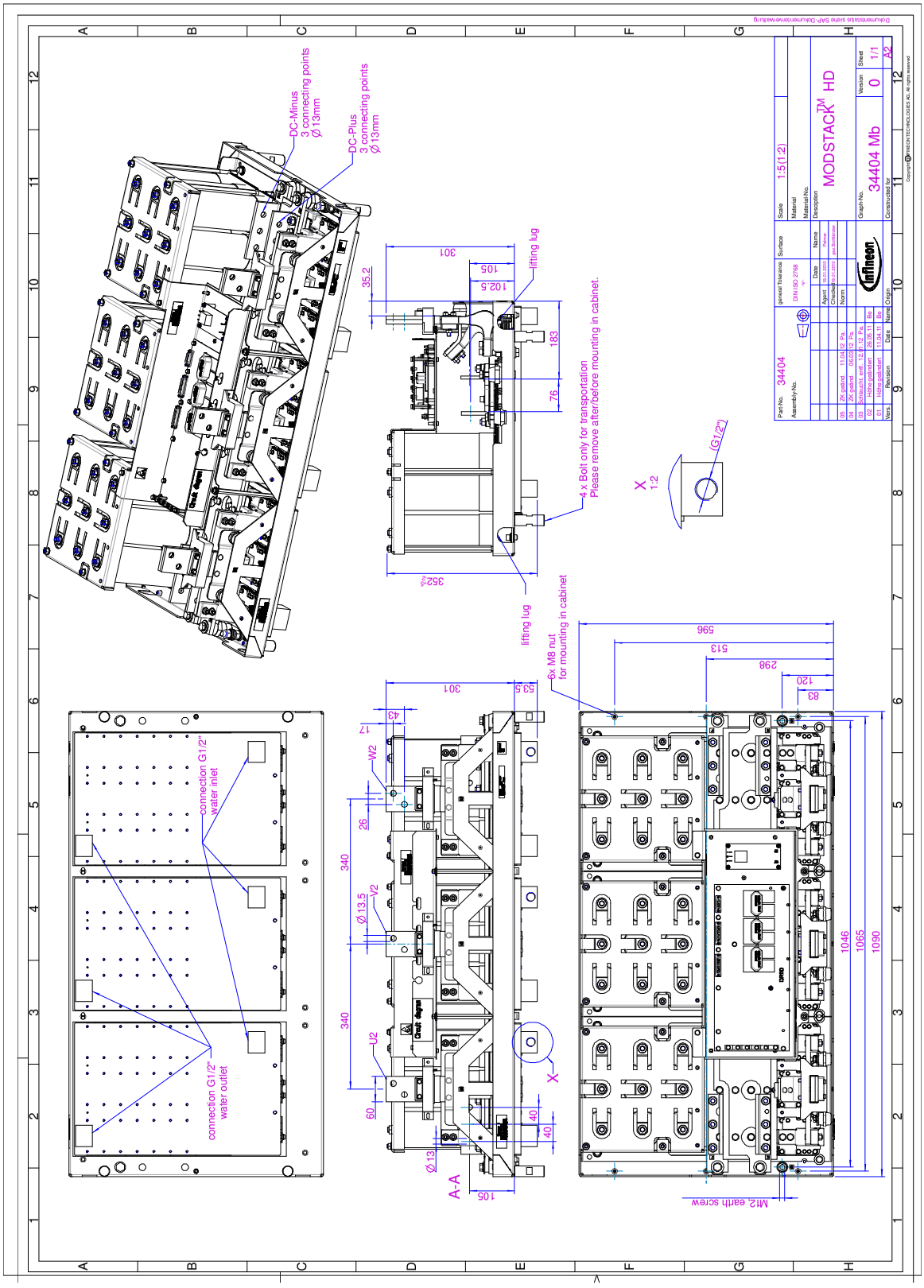
Mechanical drawing



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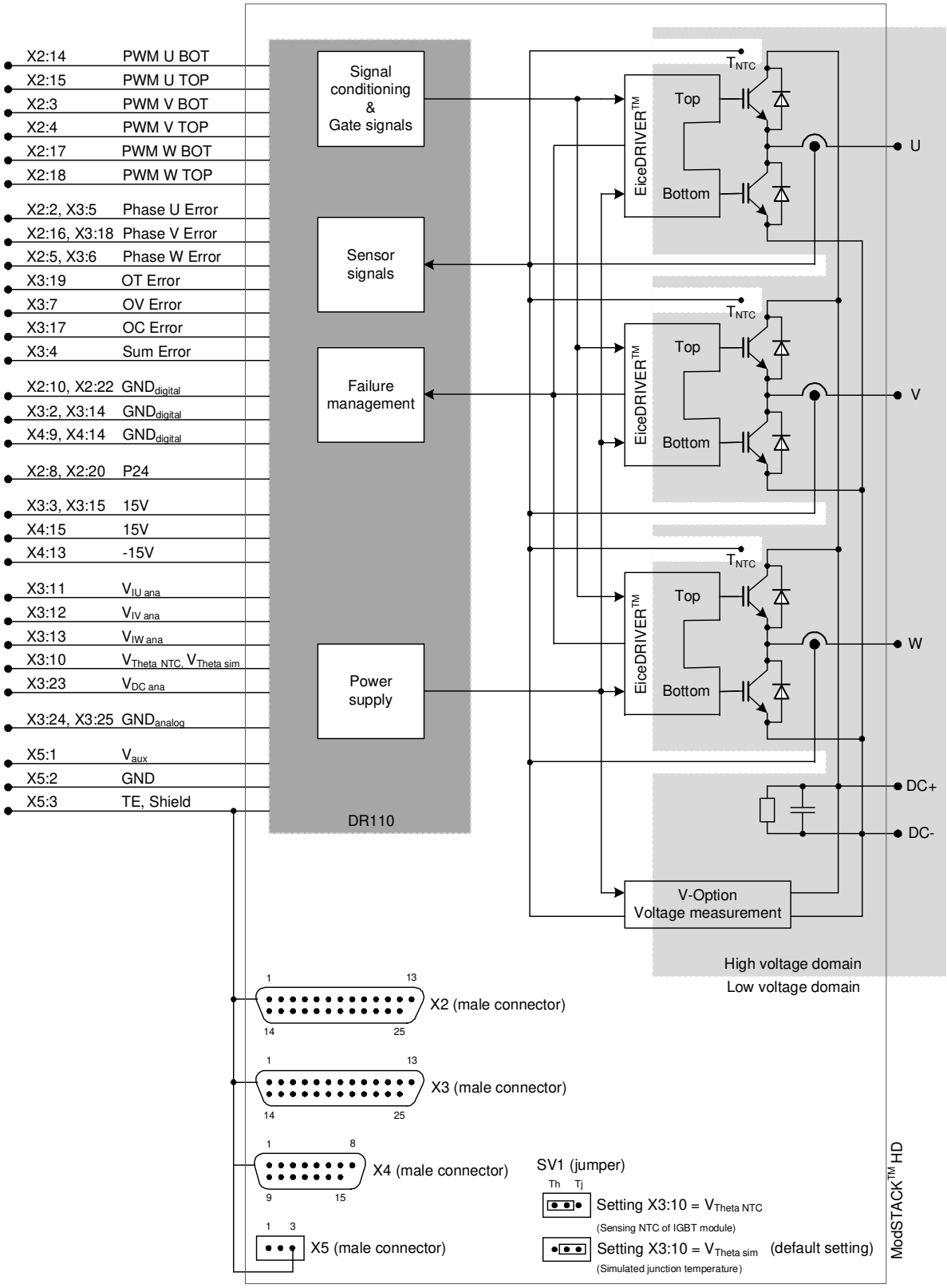
Circuit diagram



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and that we may make delivery depended on the realization of any such measures.

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